

**ORDERING INFORMATION**

Temp. Range	Package	Part Number
<b>DG447, DG448</b>		
- 40 °C to 85 °C	6-pin TSOP	DG447DV-T1-E3
		DG448DV-T1-E3

**ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25\text{ °C}$ , unless otherwise noted)

Parameter Referenced to V-	Limit	Unit
V+	44	V
GND	25	
Digital Inputs <sup>a</sup> , $V_{no/nc}$ , $V_{COM}$	(V-) - 2 V to (V+) + 2 V or 30 mA, whichever occurs first	
Current, (Any Terminal) Continuous	30	mA
Current (NO or NC or COM) Pulsed at 1 ms, 10 % Duty Cycle	100	
Storage Temperature	- 65 to 150	°C
Power Dissipation (Package) <sup>b</sup>	6-pin TSOP <sup>c</sup>	570
		mW

Notes:

a. Signals on NO, NC, COM, or IN exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC board.

c. Derate 7 mW/°C above 70 °C.

**SPECIFICATIONS<sup>a</sup>**

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 15 V, V- = - 15 V VIN = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	D Suffix - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Max. <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full	- 15		15	V
Drain-Source On-Resistance	R <sub>ON</sub>	I <sub>no/nc</sub> = 10 mA, V <sub>COM</sub> = 10 V V+ = 13.5 V, V- = - 13.5 V	Room Full		17	25 30	Ω
On-Resistance Flatness	R <sub>ON</sub> Flatness	I <sub>no/nc</sub> = 10 mA, V <sub>COM</sub> = ± 5 V, 0 V V+ = 13.5 V, V- = - 13.5 V	Room Full		0.8	2.2 3	
Switch Off Leakage Current	I <sub>no/nc(off)</sub>	V+ = 16.5, V- = - 16.5 V V <sub>COM</sub> = ± 15.5 V V <sub>no/nc</sub> = -/+ 15.5 V	Room Full	- 1 - 10	- 0.1	1 10	nA
	I <sub>COM(off)</sub>		Room Full	- 1 - 10	- 0.1	1 10	
Channel On Leakage Current	I <sub>COM(on)</sub>	V+ = 16.5 V, V- = - 16.5 V <sub>COM</sub> = V <sub>no/nc</sub> = ± 15.5 V	Room Full	- 1 - 10	- 0.1	1 10	
Digital Control							
Input, High Voltage	I <sub>INH</sub>		Full	2.4			V
Input, Low Voltage	I <sub>INL</sub>		Full			0.8	
Input Capacitance <sup>e</sup>	C <sub>IN</sub>		Room		5		pF
Input Current	I <sub>IN</sub>	V <sub>IN</sub> = 0 or 5 V		- 1		1	μA
Dynamic Characteristics							
Turn-On Time	t <sub>ON</sub>	R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF V <sub>no/nc</sub> = ± 10 V	Room Full		100	130 140	ns
Turn-Off Time	t <sub>OFF</sub>		Room Full		50	95 110	
Charge Injection <sup>e</sup>	Q	C <sub>L</sub> = 10 nF, V <sub>gen</sub> = 0 V, R <sub>gen</sub> = 0 Ω	Room		10		pC
Off-Isolation <sup>e</sup>	OIRR	C <sub>L</sub> = 5 pF, R <sub>L</sub> = 50 Ω, f = 1 MHz	Room		- 72		dB
Source Off Capacitance <sup>e</sup>	C <sub>S(off)</sub>	f = 1 MHz	Room		19		pF
Drain Off Capacitance <sup>e</sup>	C <sub>D(off)</sub>		Room		8		
Channel On Capacitance <sup>e</sup>	C <sub>D(on)</sub>	f = 1 MHz	Room		30		
Power Supplies							
Positive Supply Current	I+	V+ = 16.5 V, V- = - 16.5 V VIN = 0 or 5 V	Room Full		16	30 50	μA
Negative Supply Current	I-		Room Full	- 1 - 10	- 0.02		

**SPECIFICATIONS<sup>a</sup>**

Parameter	Symbol	Test Conditions Unless Otherwise Specified V+ = 12 V, V- = 0 V VIN = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	D Suffix - 40 °C to 85 °C			Unit
				Min. <sup>d</sup>	Typ. <sup>c</sup>	Max. <sup>d</sup>	
Analog Switch							
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full	0		12	V
Drain-Source On-Resistance	R <sub>ON</sub>	I <sub>no/nc</sub> = - 10 mA, V <sub>COM</sub> = 8 V V+ = 10.8 V	Room Full		32	45 60	Ω
On-Resistance Flatness	R <sub>ON</sub> Flatness	I <sub>no/nc</sub> = 10 mA, V <sub>COM</sub> = 2, 6, 8 V V+ = 10.8 V	Room Full		2	6 8	Ω
Dynamic Characteristics							
Turn-On Time	t <sub>ON</sub>	V <sub>NO, NC</sub> = ± 10 V, R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF	Room Full		140	175 225	nS
Turn-Off Time	t <sub>OFF</sub>		Room Full		50	120 150	
Charge Injection <sup>e</sup>	Q	C <sub>L</sub> = 10 nF, V <sub>gen</sub> = 0 V, R <sub>gen</sub> = 0 Ω	Room		12		pC
Power Supplies							
Positive Supply Current	I+	V+ = 13.2 V, VIN = 0 V, 5 V	Room Full		22	50 75	μA

## Notes:

a. Refer to PROCESS OPTION FLOWCHART.

b. Room = 25 °C, full = as determined by the operating temperature suffix.

c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

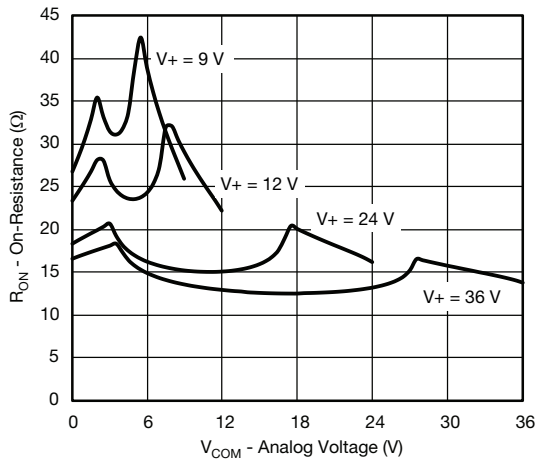
d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.

e. Guaranteed by design, not subject to production test.

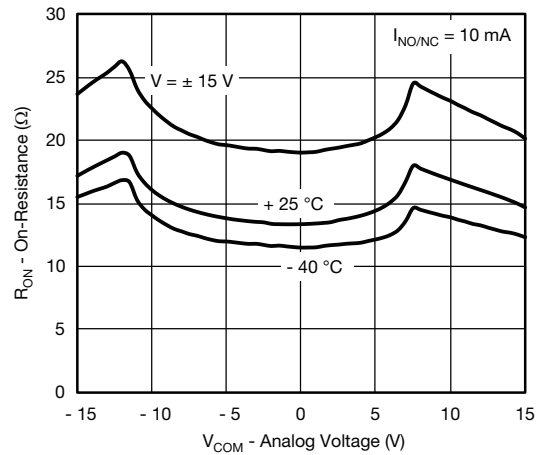
f.  $V_{IN}$  = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

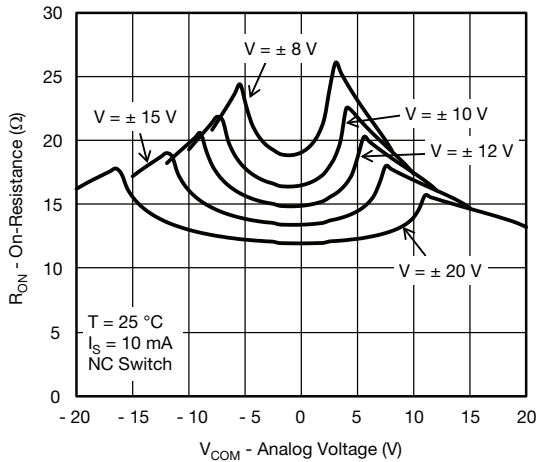
## TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)



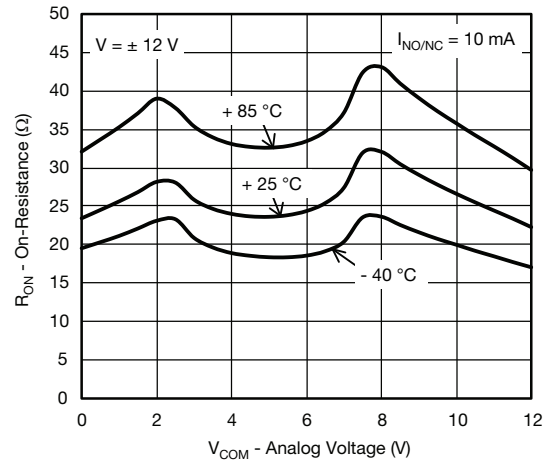
**$R_{ON}$  vs.  $V_{COM}$  and Single Supply Voltage**



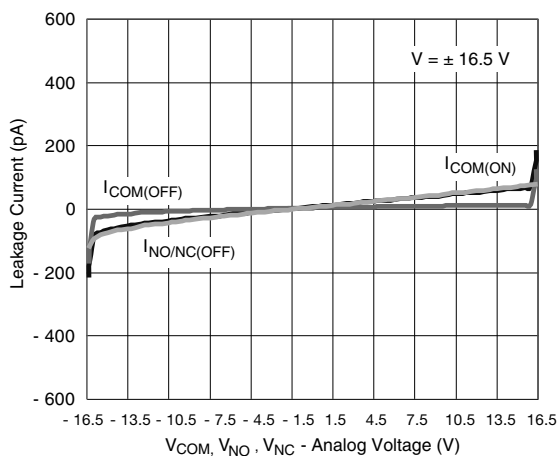
**$R_{ON}$  vs. Analog Voltage and Temperature**



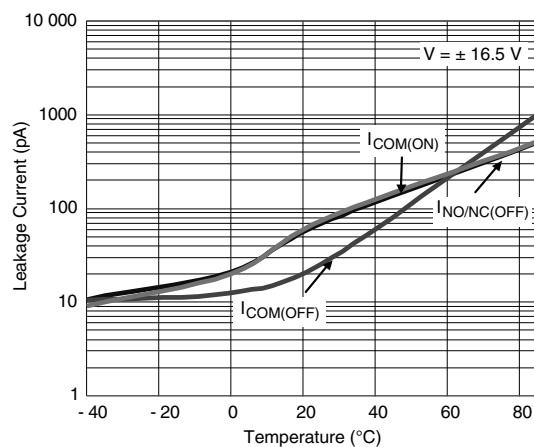
**$R_{ON}$  vs.  $V_{COM}$  and Dual Supply Voltage**



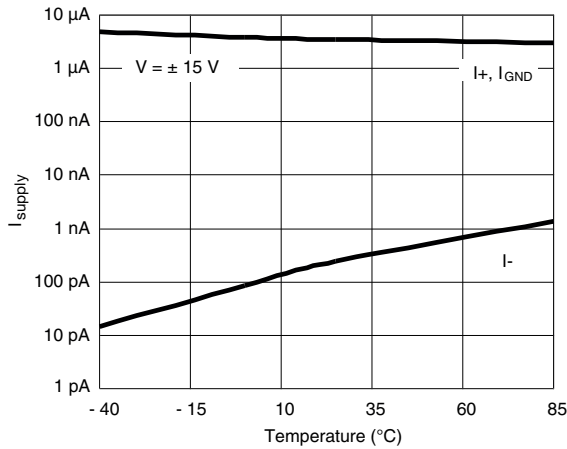
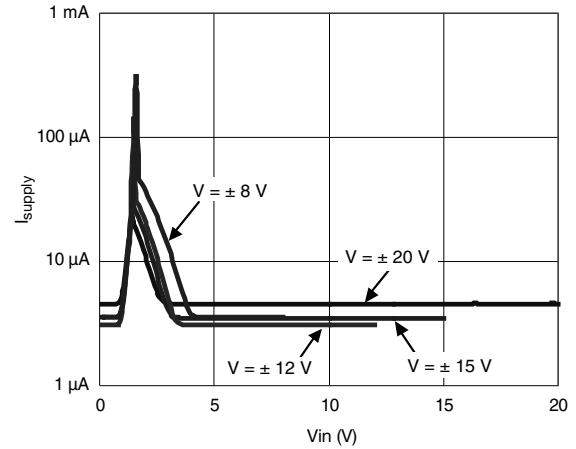
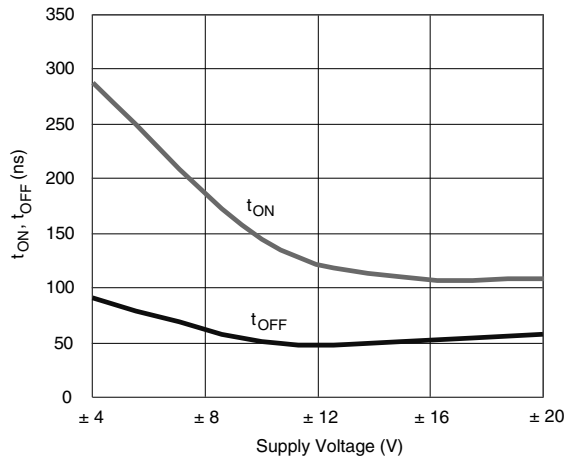
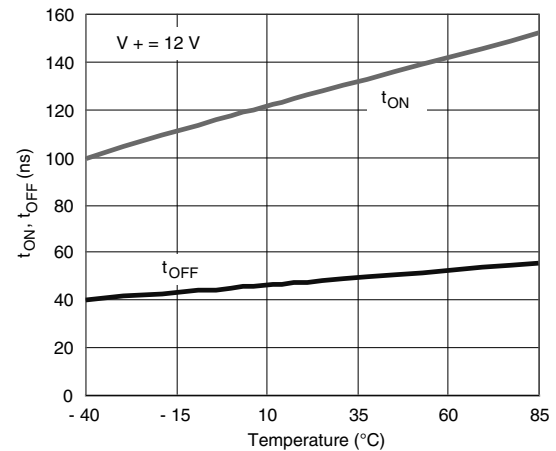
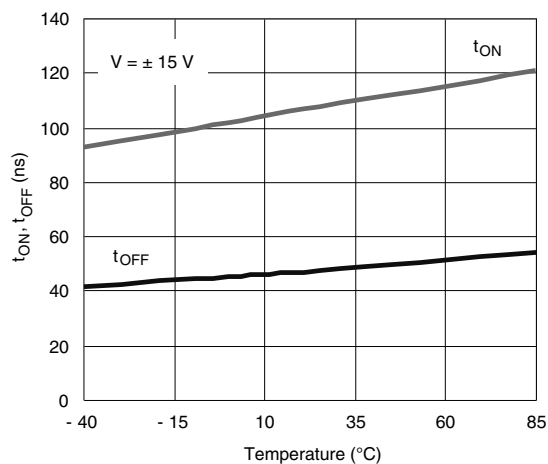
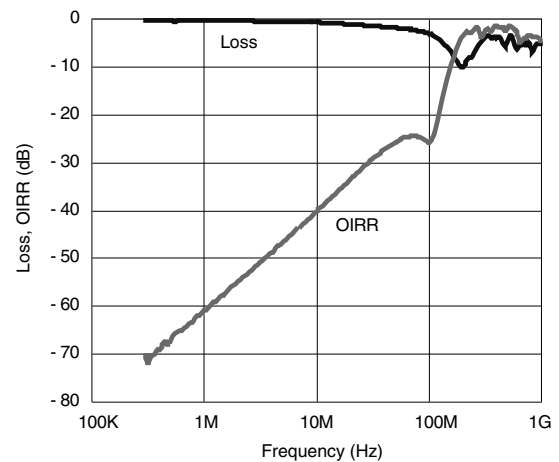
**$R_{ON}$  vs. Analog Voltage and Temperature**



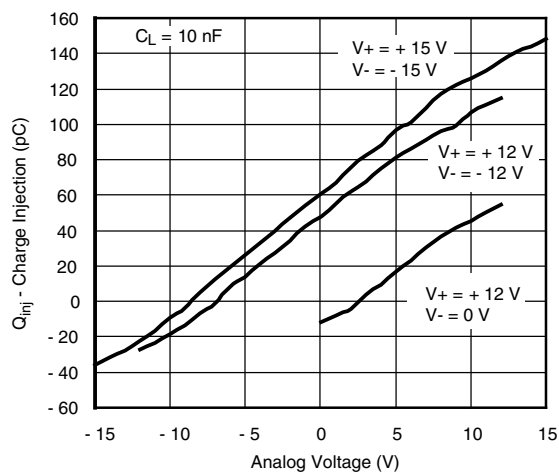
**Leakage vs. Analog Voltage**



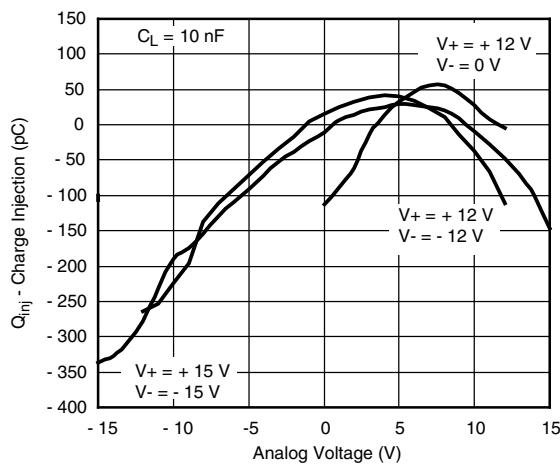
**Leakage Current vs. Temperature**

**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)**Supply Current vs. Temperature****Supply Current vs.  $V_{\text{IN}}$** **Switching Time vs. Supply Voltages****Switching Time vs. Temperature****Switching Time vs. Temperature****Off Isolation and Insertion Loss vs. Frequency**

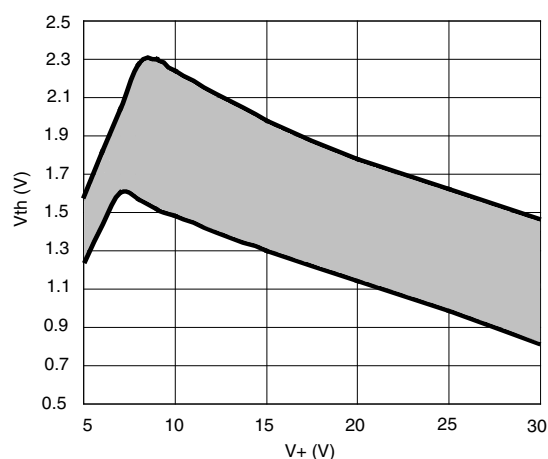
### TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)



Charge Injection vs. Analog Voltage  
(Measured at COM pin)



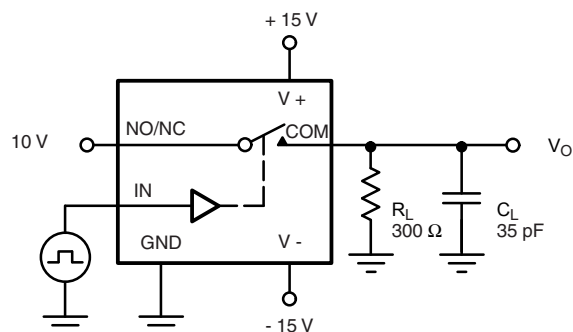
Charge Injection vs. Analog Voltage  
(Measured at NC or NO pin)



Input Switching Threshold vs. Supply Voltage

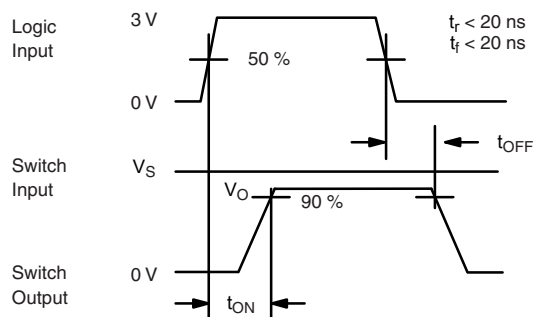
### TEST CIRCUITS

$V_O$  is the steady state output with the switch on.



$C_L$  (includes fixture and stray capacitance)

$$V_O = V_S \frac{R_L}{R_L + r_{ON}}$$



Note: Logic input waveform is inverted for switches that have the opposite logic sense.

Figure 1. Switching Time

## TEST CIRCUITS

$V_O$  is the steady state output with the switch on.

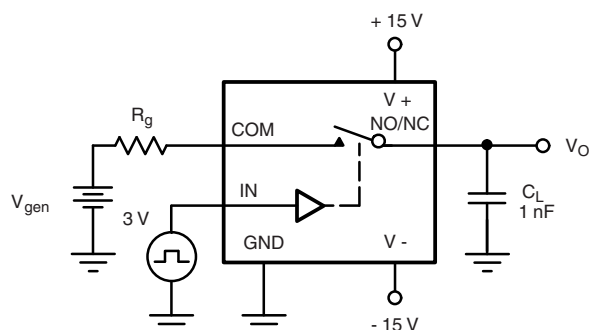


Figure 2. Charge Injection

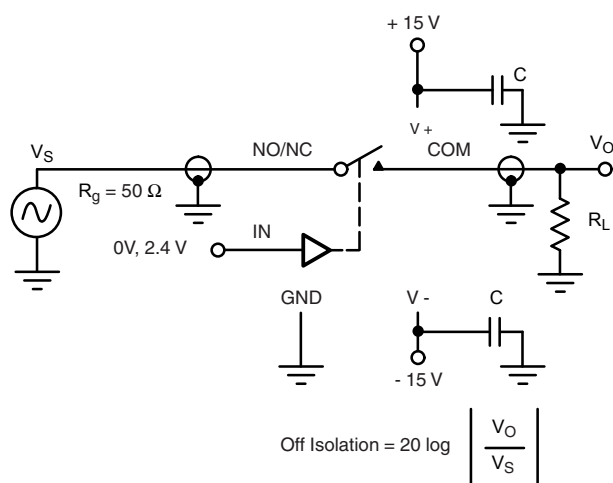


Figure 3. Off Isolation

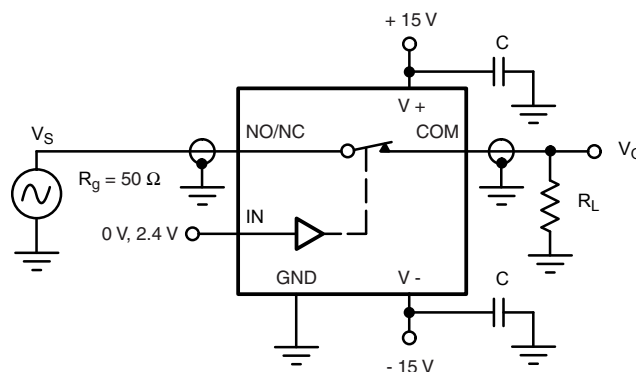


Figure 4. Insertion Loss

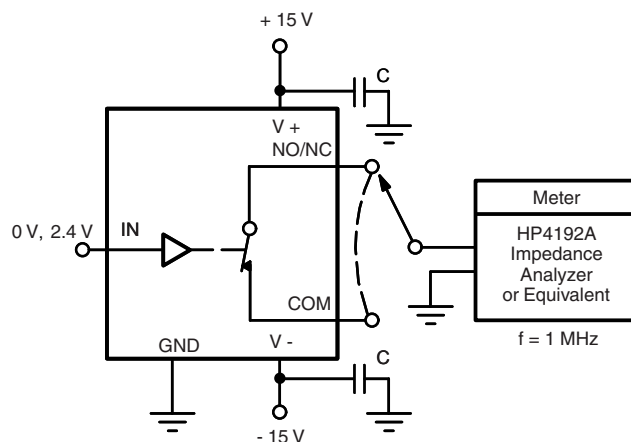
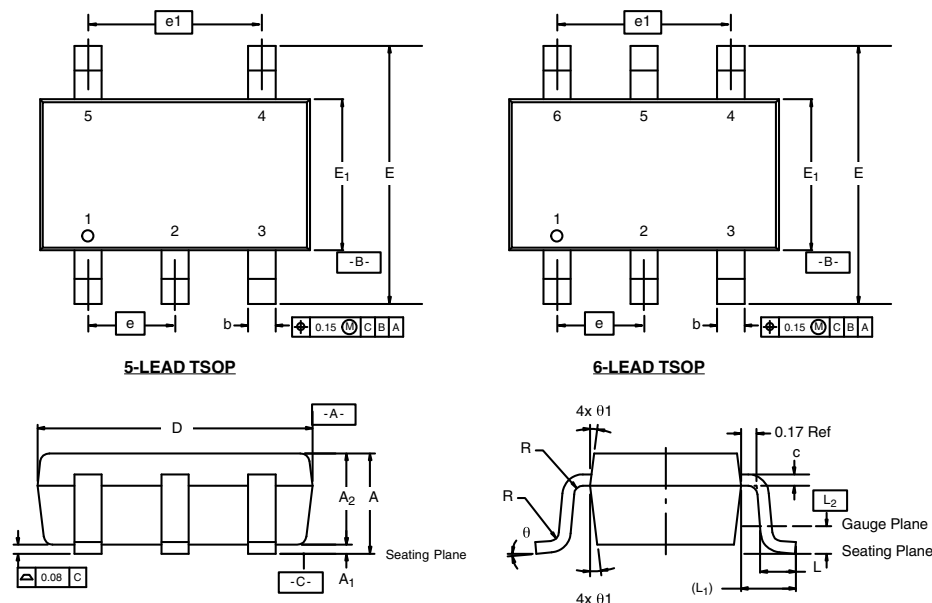


Figure 5. Source/Drain Capacitances

**TSOP: 5/6-LEAD**  
JEDEC Part Number: MO-193C



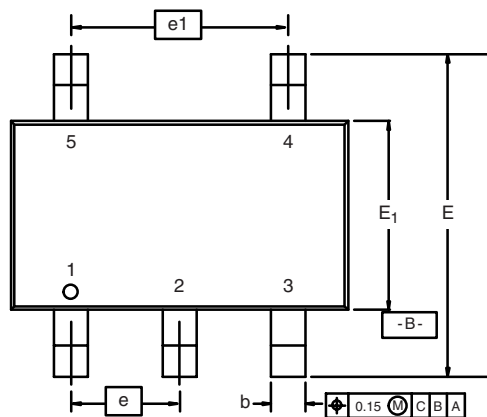
DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.91	-	1.10	0.036	-	0.043
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
e	0.95 BSC			0.0374 BSC		
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L <sub>1</sub>	0.60 Ref.			0.024 Ref.		
L <sub>2</sub>	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ <sub>1</sub>	7° Nom.			7° Nom.		

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?73854](http://www.vishay.com/ppg?73854).

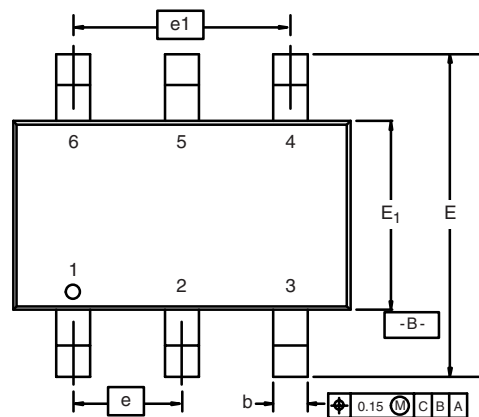


## TSOP: 5/6-LEAD

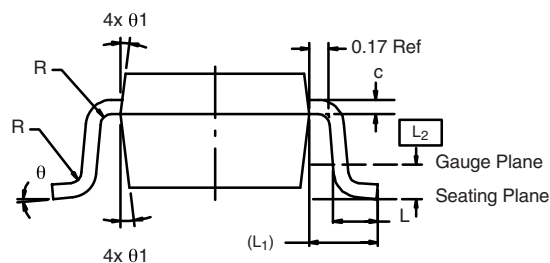
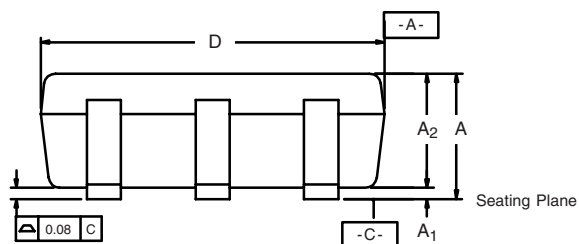
JEDEC Part Number: MO-193C



5-LEAD TSOP



6-LEAD TSOP

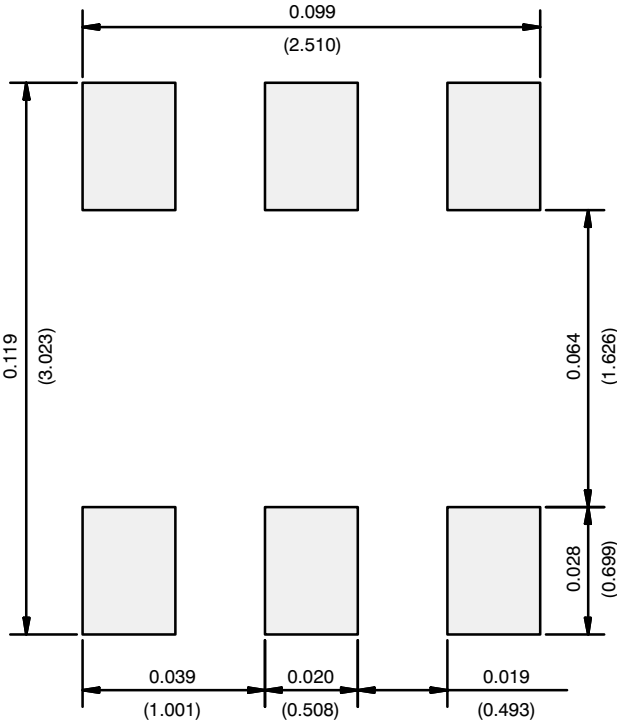


	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
A	0.91	-	1.10	0.036	-	0.043
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
e	0.95 BSC			0.0374 BSC		
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L <sub>1</sub>	0.60 Ref			0.024 Ref		
L <sub>2</sub>	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ <sub>1</sub>	7° Nom			7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06						
DWG: 5540						





RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads  
Dimensions in Inches/(mm)

[Return to Index](#)



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.